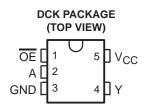
SCLS504B - JUNE 2003 - REVISED JANUARY 2008

- Qualified for Automotive Applications
- ESD Protection Exceeds 2000 V Per MIL-STD-883, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Operating Range of 3 V to 5.5 V
- Max t_{pd} of 6 ns at 5 V
- Low Power Consumption, 10-μA Max I_{CC}
- ±8-mA Output Drive at 5 V
- Inputs Are TTL-Voltage Compatible



description/ordering information

The SN74AHCT1G125 is a single bus buffer gate/line driver with 3-state output. The output is disabled when the output-enable (\overline{OE}) input is high. When \overline{OE} is low, true data is passed from the A input to the Y output.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

ORDERING INFORMATION†

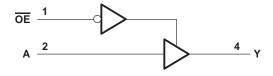
TA	PACKAGE	‡	ORDERABLE PART NUMBER	TOP-SIDE MARKING§	
-40°C to 125°C	SOT (SC-70) – DCK	Reel of 3000	CAHCT1G125QDCKRQ1	BM_	

[†] For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at http://www.ti.com.

FUNCTION TABLE

INPU	JTS	OUTPUT
OE	Α	Υ
L	Н	Н
L	L	L
Н	Χ	Z

logic diagram (positive logic)





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



[‡] Package drawings, thermal data, and symbolization are available at http://www.ti.com/packaging.

[§] The actual top-side marking has one additional character that designates the wafer fab/assembly site.

SN74AHCT1G125-Q1 SINGLE BUS BUFFER GATE WITH 3-STATE OUTPUT

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage range, V _{CC}	–0.5 V to 7 V
Input voltage range, V _I (see Note 1)	–0.5 V to 7 V
Output voltage range, V _O (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I_{IK} ($V_I < 0$)	–20 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±25 mA
Continuous current through V _{CC} or GND	±50 mA
Package thermal impedance, θ _{JA} (see Note 2)	252°C/W
Storage temperature range, T _{stq}	–65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

		MIN	MAX	UNIT
VCC	Supply voltage	3	5.5	V
	$V_{CC} = 3.0 \text{ V}$	1.4		
VIH	High-level input voltage $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$	2		V
	$V_{CC} = 3.0 \text{ V}$		0.53	.,
VIL	Low-level input voltage $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		0.8	V
VI	V _I Input voltage			
Vo	Output voltage	0	VCC	V
IOH	High-level output current		-8	mA
loL	Low-level output current		8	mA
Δt/Δν	Input transition rise or fall rate		20	ns/V
TA	Operating free-air temperature	-40	125	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

242445752	TEST SOURITIONS	.,	T,	ղ = 25°C	;			UNIT
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	
	15 50	3 V	2.9	3		2.9		
V	IOH = -50 μA	4.5 V	4.4	4.5		4.4		V
VOH	I _{OH} = -4 mA	3 V	2.58			2.34		V
	$I_{OH} = -8 \text{ mA}$	4.5 V	3.94			3.66		
	Ι _{ΟL} = 50 μΑ	3 V and 4.5 V			0.1		0.1	
VOL	I _{OL} = 4 mA	3 V			0.36		0.52	V
	I _{OL} = 8 mA	4.5 V			0.36		0.52	
lį	$V_I = 5.5 \text{ V or GND}$	0 V to 5.5 V			±0.1		±1	μΑ
loz	$V_O = V_{CC}$ or GND	5.5 V			±0.25		±2.5	μΑ
ICC	$V_I = V_{CC}$ or GND, $I_O = 0$, \overline{OE} high or low	3 V and 5.5 V			1		10	μΑ
∆l _{CC} †	One input at 3.4 V, Other input at V _{CC} or GND	5.5 V			1.35		1.5	mA
C _i	$V_I = V_{CC}$ or GND	5 V		4	10		10	pF
Co	$V_O = V_{CC}$ or GND	5 V		10				pF

[†] This is the increase in supply current for each input at one of the specified TTL voltage levels, rather than 0 V or VCC.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	LOAD	T _A =	: 25°C		MIN MAX	LINUT	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN 7	ГҮР	MAX	MIN MAX	UNIT	
t _{PLH}	•	Y	0. 45 = 5		5.6	8	12		
t _{PHL}	А	Y	C _L = 15 pF		5.6	8	12	ns	
^t PZH	<u>OE</u>	V	0 45 - 5		5.4	8	11.5		
tpzL	OE	Y C _L = 15 pF		5.4	8	11.5	ns		
^t PHZ	ŌĒ	Y	C _L = 15 pF		6.5	9.7	14.5		
t _{PLZ}	OE	Ť	OL = 15 pr		6.5	9.7	14.5	ns	
^t PLH			0 50 - 5		8.1	11.5	16		
t _{PHL}	А	Y $C_L = 50 \text{ pF}$			8.1	11.5	16	ns	
^t PZH	OE	.,		0 50 = 5		7.9	11.5	15	
tPZL	OE	Υ	$C_L = 50 pF$		7.9	11.5	15	ns	
^t PHZ	ŌĒ	V	C: - 50 pF		8	13.2	18		
^t PLZ	OE .	Y $C_L = 50 \text{ pF}$			8	13.2	18	ns	

SN74AHCT1G125-Q1 SINGLE BUS BUFFER GATE WITH 3-STATE OUTPUT

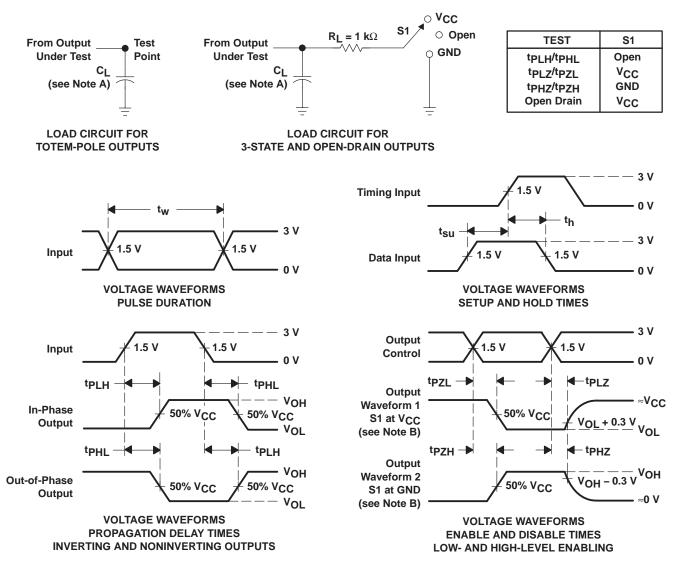
switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	LOAD	Τ _Δ	√ = 25°C	;		BAAV	
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	UNIT
^t PLH	^	Υ	0. 45 = 5		3.8	5.5		8.5	
^t PHL	А	Ť	C _L = 15 pF		3.8	5.5		8.5	ns
^t PZH	<u>OE</u>	V	C: 45 pF		3.6	5.1		7.5	
t _{PZL}	OE	Υ	C _L = 15 pF		3.6	5.1		7.5	ns
^t PHZ	<u>OE</u>	Y	C _L = 15 pF		4.8	6.8		10	ns
t _{PLZ}	OE	ı	OL = 13 pr		4.8	6.8		10	115
^t PLH	•	V	0 50 - 5		5.3	7.5		10.5	
^t PHL	А	Y C _L = 50 pF			5.3	7.5		10.5	ns
^t PZH	ŌĒ	V	0 50 - 5		5.1	7.1		9.5	
t _{PZL}	OE	Υ	C _L = 50 pF		5.1	7.1		9.5	ns
^t PHZ	ŌĒ	Y	C _L = 50 pF		7	8.8		12	no
t _{PLZ}	OE .	CL = 50 pr		7	8.8		12	ns	

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER		TEST C	ONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load,	f = 1 MHz	14	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_Q = 50 \Omega$, $t_f \leq 3$ ns. $t_f \leq 3$ ns.
- D. The outputs are measured one at a time with one input transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms







v.ti.com 18-Sep-2008

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing		ckage Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
CAHCT1G125QDCKRQ1	ACTIVE	SC70	DCK	5 3	000	TBD	CU SNPB	Level-1-235C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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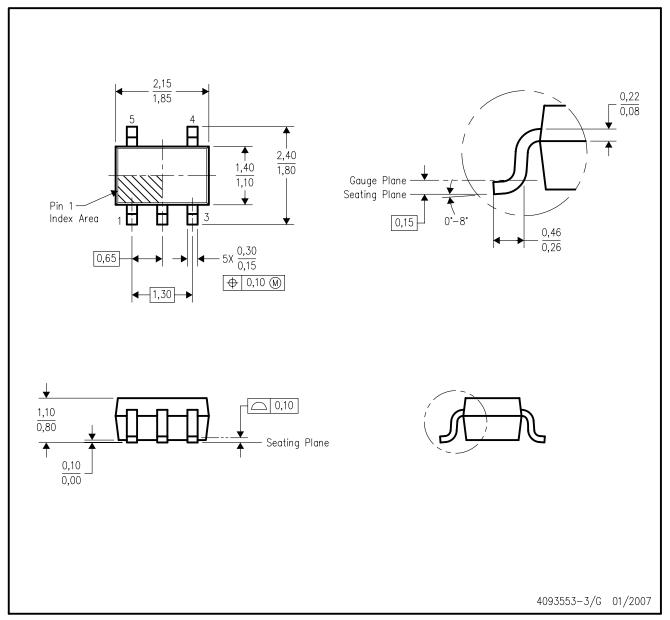
Catalog: SN74AHCT1G125

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-203 variation AA.



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